

Acid Copper (Bright Copper) Plating Guide for Beginners

Brush / Tampon and Bath Plating

This guide is easy to understand, beginner-friendly, and aligned with common industry practice. It applies equally to brush/tampon plating and bath plating using an acid copper / bright copper electrolyte (e.g. BMG-095M).

1. What Is Acid Copper Plating?

Acid copper plating is an electrochemical process that deposits a very smooth, bright copper layer onto a conductive surface.

Acid copper is mainly used for:

- decorative high-gloss copper finishes
- metallization of conductive paints
- copper plating on aluminum (alloy-dependent)
- leveling fine surface defects
- preparation for nickel, silver, or gold when high smoothness is required

→ Acid copper is not intended as corrosion protection for steel.

2. Acid vs. Alkaline Copper (simple explanation)

Acid copper:

- very bright and smooth
- decorative and leveling
- lower adhesion on steel

Alkaline copper:

- excellent adhesion
- ideal for steel and iron
- strong build-up and corrosion protection

3. Suitable Materials

Directly suitable:

- Copper
- Brass
- Bronze
- Nickel
- Silver
- Conductive coatings

Conditionally suitable:

- Aluminum (depending on alloy and activation)

Not recommended:

- Steel or iron without alkaline copper undercoat

4. Safety

Acid copper electrolytes may cause irritation:

- Wear protective gloves
- Wear safety goggles
- Avoid skin and eye contact
- Work in a well-ventilated area

5. Surface Preparation

5.1 Sanding & Polishing

- Prepare surface matte to high-gloss, as desired
- Acid copper reproduces surface texture exactly

5.2 Cleaning & Activation

- Remove oil, grease, and oxides completely
- Degrease thoroughly with electro cleaner
- Lightly activate surface (acidic)
- Handle only with gloves afterward

6. Electrical Connections

- Negative (-): workpiece (cathode)
- Positive (+): electrode or anode pad

Electrodes:

- Copper or graphite electrode (bath)
- Fabric/cotton pad (brush plating)

7. Technical Parameters (Beginner Guidelines)

- Voltage: approx. 1.5–4 V
- Temperature: room temperature up to ~30–35 °C
- Deposition: fast and very smooth

→ Excess voltage causes dark or rough deposits.

8. Acid Copper Bath Plating

Additional notes:

- Place workpiece centrally
- Distribute anodes evenly
- Never use steel anodes
- Gentle agitation improves brightness

Procedure:

1. Slightly warm electrolyte if needed
2. Connect workpiece (negative)
3. Connect anode (positive)
4. Slowly raise voltage
5. Plate evenly
6. Remove and rinse

9. Brush / Tampon Acid Copper Plating

Typical uses: decorative work, repairs, metallization

Additional notes:

- Keep pad clean and well soaked
- Use smooth, continuous movement
- Do not stay in one spot

Procedure:

1. Soak pad with copper electrolyte
2. Workpiece to negative, electrode to positive
3. Move evenly across the surface
4. Build a bright copper layer

10. Post-Treatment & Further Plating

- **Rinse immediately with water**
- **Dry gently**
- **Copper can be:**
 - **polished**
 - **nickel plated**
 - **silver plated**
 - **gold plated**

11. Common Beginner Issues

Dark or dull deposit: voltage too high, poor cleaning

Poor adhesion: unsuitable substrate, missing alkaline copper undercoat

Staining: uneven movement or touching with bare fingers